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1. Global joint venture starts operations as WeEn Semiconductors

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WeEn Semiconductors





1. General description

Planar passivated Silicon Controlled Rectifier with sensitive gate in a SOT54 (TO-92) plastic package. This SCR is designed to be interfaced directly to microcontrollers, logic ICs and other low power gate trigger circuits.

2. Features and benefits

- Enhanced voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Sensitive gate
- Direct triggering from low power drivers and logic ICs

3. Applications

· General purpose switching and phase control

4. Quick reference data

Table 1. Quick reference data

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|--|--|-----|-----|-----|------|
| V_{DRM} | repetitive peak off- state voltage | | - | - | 600 | V |
| V_{RRM} | repetitive peak reverse voltage | | - | - | 600 | V |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; $T_{j(init)} = 25 \text{ °C}$; $t_p = 10 \text{ ms}$; $Fig. 4$; $Fig. 5$ | - | - | 8 | Α |
| | | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 8.3 ms | - | - | 9 | Α |
| Tj | junction temperature | | - | - | 125 | °C |
| $I_{T(AV)}$ | average on-state current | half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 1</u> | - | - | 0.5 | Α |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 2</u> ; <u>Fig. 3</u> | - | - | 0.8 | А |
| Static charac | cteristics | | | | | |
| I _{GT} | gate trigger current | $V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 \text{ °C};$ Fig. 7 | - | 50 | 200 | μΑ |
| Dynamic cha | aracteristics | | ' | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 402 V; T_j = 125 °C; R_{GK} = 1 kΩ; $(V_{DM}$ = 67% of V_{DRM}); exponential waveform; Fig. 12 | 500 | 800 | - | V/µs |

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5. Ordering information

Table 2. Ordering information

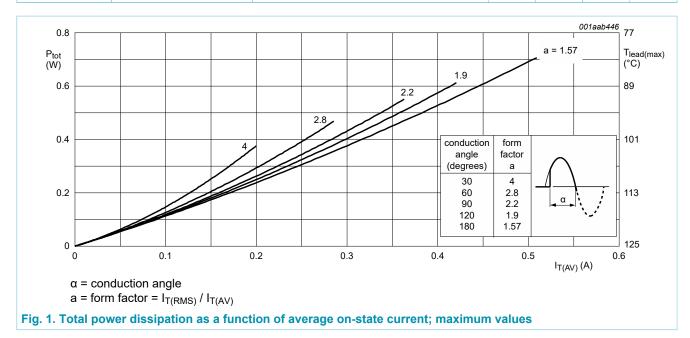
| Type number | Package | | | |
|-------------|---------|---|---------|--|
| | Name | Description | Version | |
| BT149G | TO-92 | plastic single-ended leaded (through hole) package; 3 leads | SOT54 | |

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6. Limiting values

Table 3. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---------------------|--|--|-----|------|------|
| V_{DRM} | repetitive peak off-state voltage | | - | 600 | V |
| V_{RRM} | repetitive peak reverse voltage | | - | 600 | V |
| I _{T(AV)} | average on-state current | half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 1</u> | - | 0.5 | Α |
| I _{T(RMS)} | RMS on-state current | half sine wave; T _{lead} ≤ 83 °C; <u>Fig. 2</u> ; <u>Fig. 3</u> | - | 8.0 | Α |
| I _{TSM} | non-repetitive peak on- state current | half sine wave; $T_{j(init)}$ = 25 °C; t_p = 10 ms; Fig. 4; Fig. 5 | - | 8 | А |
| | | half sine wave; T _{j(init)} = 25 °C; t _p = 8.3 ms | - | 9 | Α |
| I ² t | I ² t for fusing | t_p = 10 ms; SIN | - | 0.32 | A²s |
| dl _T /dt | rate of rise of on-state current | $I_T = 2 \text{ A}$; $I_G = 10 \text{ mA}$; $dI_G/dt = 100 \text{ mA/}\mu\text{s}$ | - | 50 | A/µs |
| I _{GM} | peak gate current | | - | 1 | Α |
| V_{RGM} | peak reverse gate voltage | | - | 5 | V |
| P _{GM} | peak gate power | | - | 2 | W |
| $P_{G(AV)}$ | average gate power | over any 20 ms period | - | 0.1 | W |
| T _{stg} | storage temperature | | -40 | 150 | °C |
| Tj | junction temperature | | - | 125 | °C |



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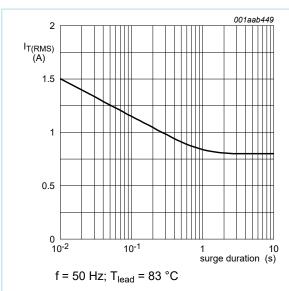


Fig. 2. RMS on-state current as a function of surge duration for sinusoidal currents

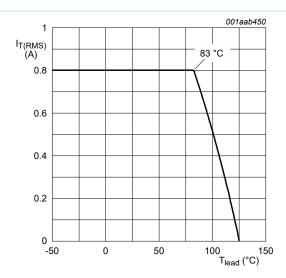


Fig. 3. RMS on-state current as a function of lead temperature; maximum values

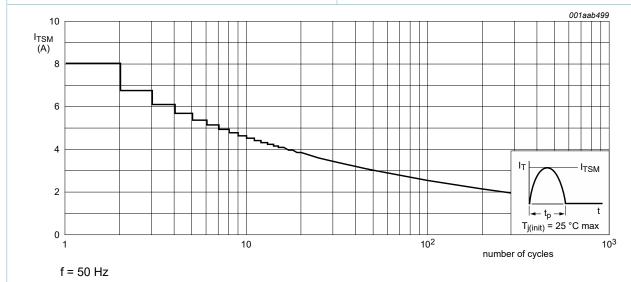
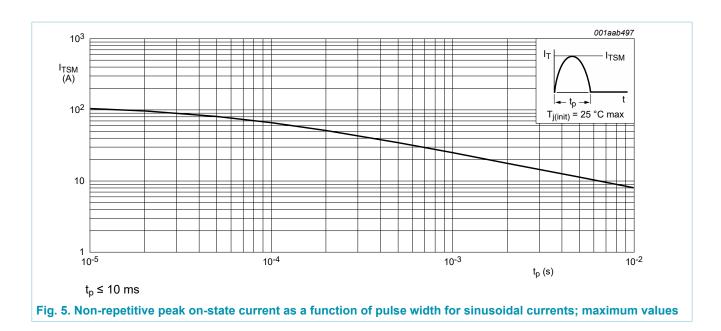


Fig. 4. Non-repetitive peak on-state current as a function of the number of sinusoidal current cycles; maximum values

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7. Thermal characteristics

Table 4. Thermal characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|-------------------------|--|---|-----|-----|-----|------|
| R _{th(j-lead)} | thermal resistance from junction to lead | <u>Fig. 6</u> | - | - | 60 | K/W |
| $R_{th(j-a)}$ | thermal resistance from junction to ambient free air | printed circuit board mounted: lead length = 4 mm | - | 150 | - | K/W |

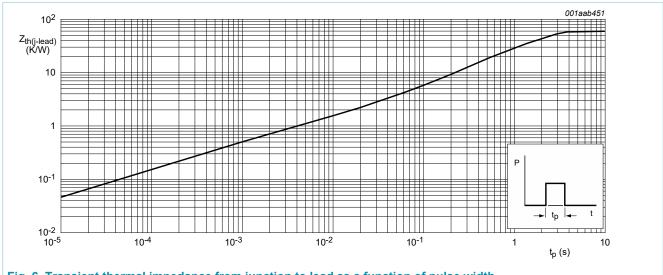


Fig. 6. Transient thermal impedance from junction to lead as a function of pulse width

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8. Characteristics

Table 5. Characteristics

| Symbol | Parameter | Conditions | Min | Тур | Max | Unit |
|---------------------|-----------------------------------|---|-----|------|-----|------|
| Static char | racteristics | | | | | |
| I _{GT} | gate trigger current | $V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 \text{ °C};$ Fig. 7 | - | 50 | 200 | μA |
| l _L | latching current | V_D = 12 V; I_G = 0.5 mA; T_j = 25 °C; $R_{GK(ext)}$ = 1 k Ω ; Fig. 8 | - | 2 | 6 | mA |
| I _H | holding current | $V_D = 12 \text{ V; } T_j = 25 \text{ °C; } R_{GK(ext)} = 1 \text{ k}\Omega;$ Fig. 9 | - | 2 | 5 | mA |
| V _T | on-state voltage | I _T = 1.2 A; T _j = 25 °C; <u>Fig. 10</u> | - | 1.25 | 1.7 | V |
| V _{GT} | gate trigger voltage | $V_D = 12 \text{ V}; I_T = 10 \text{ mA}; T_j = 25 \text{ °C};$ Fig. 11 | - | 0.5 | 0.8 | V |
| | | $V_D = 600 \text{ V}; I_T = 10 \text{ mA}; T_j = 125 ^{\circ}\text{C};$ Fig. 11 | 0.2 | 0.3 | - | V |
| I _D | off-state current | $V_D = 600 \text{ V}; R_{GK(ext)} = 1 \text{ k}\Omega; T_j = 125 ^{\circ}\text{C}$ | - | 0.05 | 0.1 | mA |
| I _R | reverse current | $V_R = 600 \text{ V}; T_j = 125 \text{ °C}; R_{GK(ext)} = 1 \text{ k}\Omega$ | - | 0.05 | 0.1 | mA |
| Dynamic c | haracteristics | | | | | |
| dV _D /dt | rate of rise of off-state voltage | V_{DM} = 402 V; T_j = 125 °C; R_{GK} = 1 kΩ; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12 | 500 | 800 | - | V/µs |
| | | V_{DM} = 402 V; T_j = 125 °C; (V_{DM} = 67% of V_{DRM}); exponential waveform; gate open circuit; Fig. 12 | - | 2 | - | V/µs |
| t _{gt} | gate-controlled turn-on time | I_{TM} = 2 A; V_D = 600 V; I_G = 10 mA; dI_G/dt = 0.1 A/ μ s; T_j = 25 °C | - | 2 | - | μs |
| t _q | commutated turn-off time | V_{DM} = 402 V; T_j = 125 °C; I_{TM} = 1.6 A; V_R = 35 V; $(dI_T/dt)_M$ = 30 A/ μ s; dV_D/dt = 2 V/ μ s; $R_{GK(ext)}$ = 1 k Ω ; $(V_{DM}$ = 67% of $V_{DRM})$ | - | 100 | - | μs |

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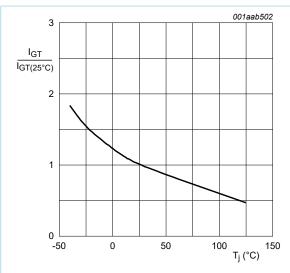


Fig. 7. Normalized gate trigger current as a function of junction temperature

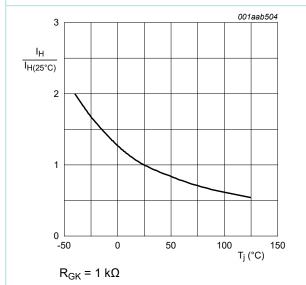


Fig. 9. Normalized holding current as a function of junction temperature

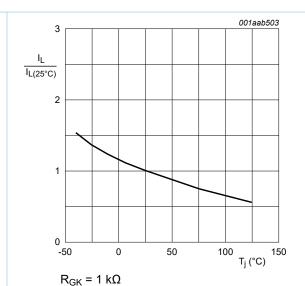
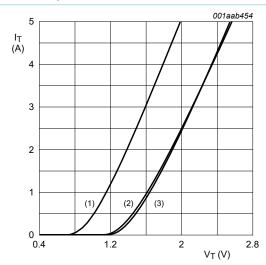


Fig. 8. Normalized latching current as a function of junction temperature



 V_o = 1.067 V; R_s = 0.187 Ω

(1) T_i = 125 °C; typical values

(2) T_j = 125 °C; maximum values (3) T_j = 25 °C; maximum values

Fig. 10. On-state current as a function of on-state voltage

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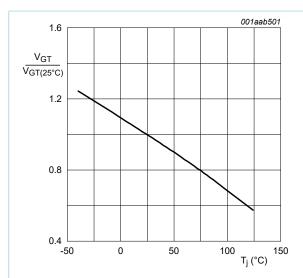


Fig. 11. Normalized gate trigger voltage as a function of junction temperature

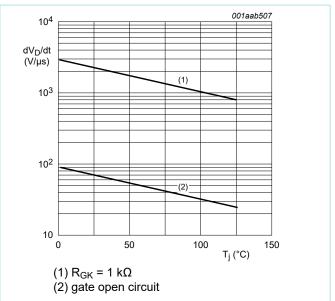
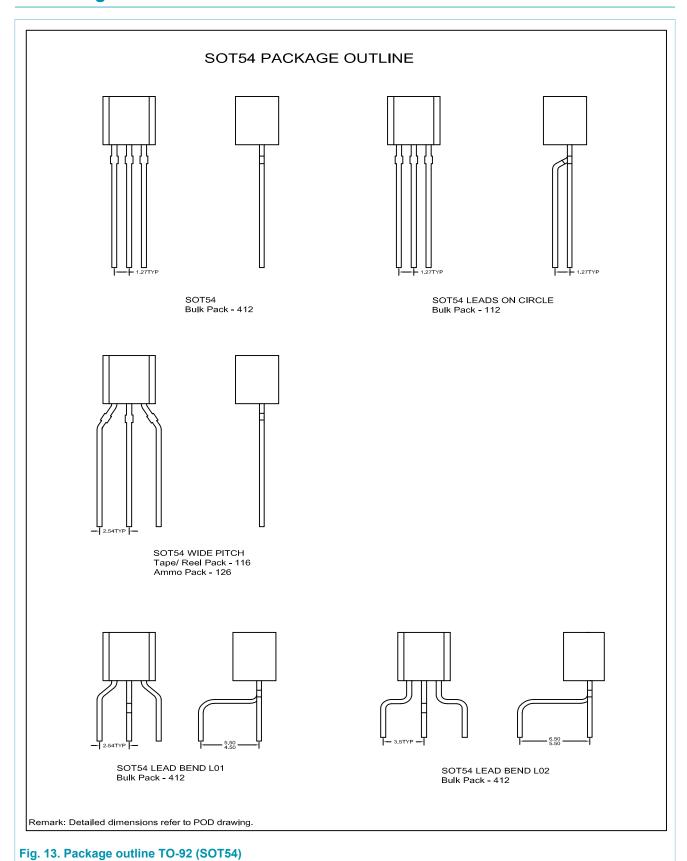


Fig. 12. Critical rate of rise of off-state voltage as a function of junction temperature; typical values

9. Package outline



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10. Legal information

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| Document status [1][2] | Product status [3] | Definition |
|--------------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
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11. Contents

| 1. | General description | 1 |
|-----|-------------------------|----|
| 2. | Features and benefits | 1 |
| 3. | Applications | 1 |
| 4. | Quick reference data | 1 |
| 5. | Ordering information | 2 |
| 6. | Limiting values | 3 |
| 7. | Thermal characteristics | ε |
| 8. | Characteristics | 7 |
| 9. | Package outline | 10 |
| 10. | . Legal information | 11 |

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